X12SPT-GC (For SuperServer Only)



GrandTwin UP Serverboard

Key Features

3rd Gen Intel[®] Xeon[®] Scalable processors

Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP

Intel[®] C621A

Up to 4TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-3200MHz

Up to 2TB Intel[®] Optane[™] Persistent Memory 200 Series, in 16 DIMM slots

1x PCIe 4.0 x8 4C connector (for front I/O module), 4x PCIe 4.0 x8 MCIO connectors

LSI 3808 controller for 6 SAS3 ports

M.2 Interface: 2 PCIe 3.0 x4&SATA, M.2 Form Factor: 2280

Optimized Servers

SYS-210GT-HNC8F

Specifications

Product SKUs	Expansion Slots
MBD-X12SPT-GC	PCIe
Physical Stats	N/A
Form Factor	
Proprietary	M.2 Interface: 2 SATA/PCIe 3.0 x4, RAID 0 & 1
Dimension	Form Factor: 2280
8.53" x 12.42" (21.67cm x 31.55cm)	Кеу: М-Кеу
Processor	System BIOS
	BIOS Type
3rd Gen Intel [®] Xeon [®] Scalable processors	AMI UEFI
Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to	Management
	Software
Core	<u>Redfish API, Supermicro Server Manager (SSM),</u>
Up to 40 cores	<u>Supermicro Power Manager (SPM), Supermicro Update</u>
System Memory	Manager (SUM), SuperDoctor [®] 5, Super Diagnostics Offlir
Memory Capacity 16 DIMM slots	, KVM with dedicated LAN , IPMI 2.0
Up to 2TB Intel® Optane™ Persistent Memory 200 Series	System Management Software
	IPMI (Intelligent Platform Management Interface) v1.5 / 2.0 with KVM
Up to 2TB ECC LRDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz; Up to 2TB ECC RDIMM, DDR4-3200MHz; Up to 2TB 3DS	support
ECC RDIMM, DDR4-3200MHz	Power Configurations
Memory Type	Power-on mode for AC power recovery, ACPI Power Management
3200/2933/2666 MT/s ECC , DDR4 LRDIMM, RDIMM	Security
DIMM Sizes	Hardware
8GB, 16GB, 32GB, 64GB, 128GB, 256GB	Trusted Platform Module (TPM) 2.0
DCPMM: 64GB, 128GB, 256GB	PC Health Monitoring
LRDIMM: 64GB, 128GB	Voltage
LRDIMM: 128GB, 256GB	VBAT, PCH temperature, Memory temperature, CPU temperature, +5V
RDIMM: 8GB, 16GB, 32GB, 64GB	standby, +5V, +3.3V, +12V, +1.8V, VRM temperature, Memory Voltages,
RDIMM: 64GB, 128GB, 256GB	CPU thermal trip support
Memory Voltage	LED
1.2V	UID/Remote UID
Error Detection	BMC/IPMI Heartbeat LED
Corrects single-bit errors	Other Features
On-Board Devices	WOL, UID, RoHS, Node Manager Support, RoT, NCSI header
Chipset	FAN
Intel® C621A	1x 4-pin fan header (up to 1 fan)
SAS	Operating Environment
Broadcom 3808 SAS3 (12 Gbps) controller for 6 SAS3 (6 Gbps) ports	Operating Temperature Range
Graphics	10°C - 35°C (50°F - 95°F) Non Operating Temperature Pange
1 ASPEED AST2600 BMC port(s)	Non-Operating Temperature Range -40°C - 70°C (-40°F - 158°F)
Network Controllers	Operating Relative Humidity Range
N/A	8% - 90% (non-condensing)
Input / Output	Non Operating Relative Humidity Range
Serial Port	5% - 95% (non-condensing)
1 COM Port(s) (1 header)	
ТРМ	
1 TPM Header	

Parts List

Optional Parts

TPM security module (optional, not included)

Part Number	AOM-TPM-9671V	AOM-TPM-9670V
Qty	1	1
Description	SPI capable TPM 1.2 with Infineon 9670 controller with vertical form factor	SPI capable TPM 2.0 with Infineon 9670 controller with vertical form factor